

Electronic Patent Application Fee Transmittal

Application Number:	10824111			
Filing Date:	14-Apr-2004			
Title of Invention:	WAFER-LEVEL ELECTRONIC MODULES WITH INTEGRAL CONNECTOR CONTACTS			
First Named Inventor/Applicant Name:	Seung Duk Baek			
Filer:	Robert M. Meeks/Susan Freedman			
Attorney Docket Number:	5649-1279			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1740